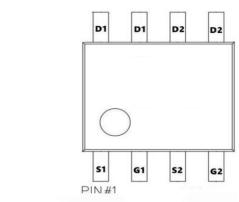
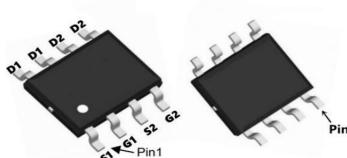


-60V P+P-Channel Enhancement Mode MOSFET

Description

The SX8V06S uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.





General Features

 $V_{DS} = -60V I_{D} = -8A$

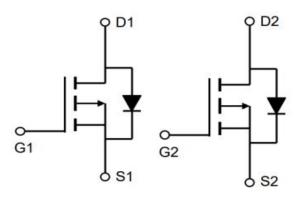
 $R_{DS(ON)} < 80 m\Omega$ @ $V_{GS}=10V$

Application

Brushless motor

Load switch

Uninterruptible power supply



Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Symbol	Parameter	Parameter Rating	
Vos	Drain-Source Voltage	-60	V
Vgs	Gate-Source Voltage	±20	V
lo@Ta=25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-8	А
lo@Ta=70°C	Continuous Drain Current, V _{GS} @ -10V ¹	-3	А
І рм	Pulsed Drain Current ²	-30	А
Pb@Ta=25°C	Total Power Dissipation ⁴	1.5	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-Ambient ¹	70	°C/W
Rejc	Thermal Resistance Junction-Case ¹	36 °C/M	

-60V P+P-Channel Enhancement Mode MOSFET





Electrical Characteristics (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	Vgs=0V , Ip=-250uA	-60			V	
$\triangle BVDSS / \triangle Tj$	BV _{DSS} Temperature Coefficient	Reference to 25℃, I _D =-1mA		-0.03		V/°C	
DDG(QNI)	Static Drain-Source On-Resistance	Vgs=-10V , Ip=-12A		60	80	mΩ	
RDS(ON)		Vgs=-4.5V , ID=-8A		64	105		
VGS(th)	Gate Threshold Voltage	V V 1 050 A	-1.2	1.5	-2.5	V	
$\triangle V$ GS(th)	V _{GS(th)} Temperature Coefficient	Vgs=Vds , ld =-250uA		4.56		mV/℃	
IDSS	Drain-Source Leakage Current	V _{DS} =-48V , V _{GS} =0V , T _J =25℃			1		
		V _{DS} =-48V , V _{GS} =0V , T _J =55℃			5	uA	
IGSS	Gate-Source Leakage Current	Vgs=±20V , Vps=0V			±100	nA	
gfs	Forward Transconductance	Vps=-5V , Ip=-12A		15.4		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		13.5		Ω	
Qg	Total Gate Charge (-4.5V)			9.86		nC	
Qgs	Gate-Source Charge	VDS=-48V , VGS=-4.5V , ID=-10A		3.08			
Qgd	Gate-Drain Charge			2.95			
Td(on)	Turn-On Delay Time			28.8		ns	
Tr	Rise Time	V _{DD} =-15V , V _{GS} =-10V ,		19.8			
Td(off)	Turn-Off Delay Time	Rg=3.3□, b=-1A		60.8			
Tf	Fall Time			7.2			
Ciss	Input Capacitance			1447			
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		97.3		pF	
Crss	Reverse Transfer Capacitance			70			
ls	Continuous Source Current ^{1,5}	V V 0V 5			-18	Α	
ISM	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			-36	Α	
VSD	Diode Forward Voltage ²	Vgs=0V , Is=-1A , Tյ=25℃			-1.2	V	
	I.						

Note:

- 1_{\times} The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2 . The data tested by pulsed , pulse width $\ \leq 300 us$, duty cycle $\ \leq 2\%$
- $3\,{\mbox{.}}$ The power dissipation is limited by $150\,{\mbox{°C}}$ junction temperature
- $4\sqrt{100}$ The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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Typical Characteristics

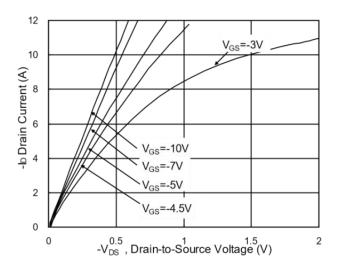


Fig.1 Typical Output Characteristics

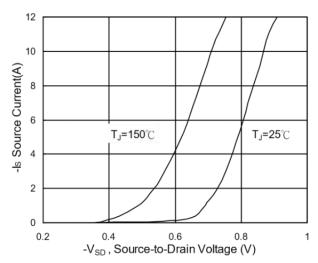


Fig.3 Forward Characteristics of Reverse

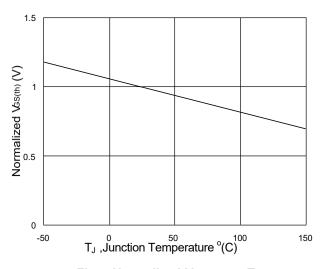


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

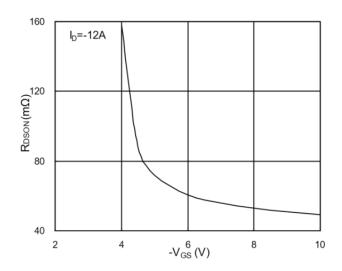


Fig.2 On-Resistance v.s Gate-Source

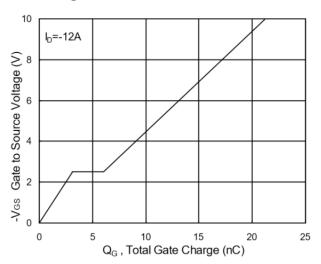


Fig.4 Gate-Charge Characteristics

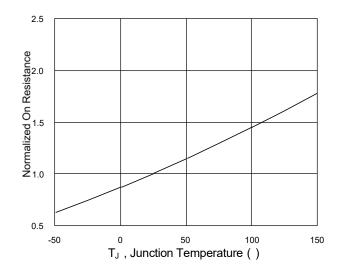
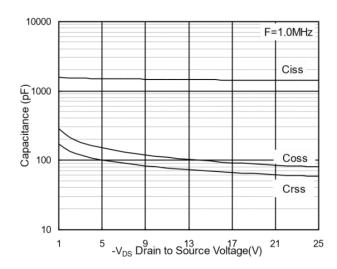


Fig. 6 Normalized R_{DSON} v.s T_J



Typical Characteristics



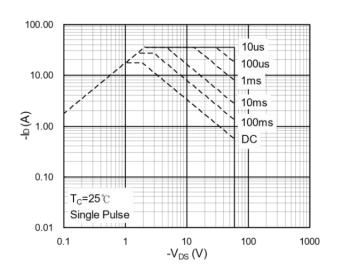


Fig.7 Capacitance

Fig.8 Safe Operating Area

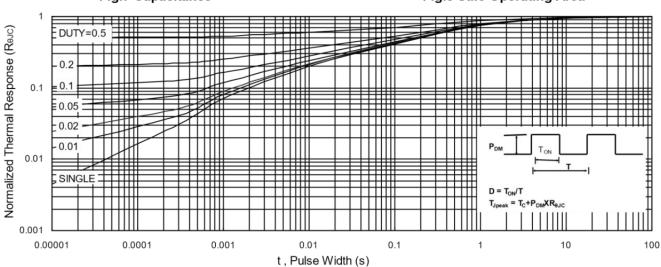


Fig.9 Normalized Maximum Transient Thermal Impedance

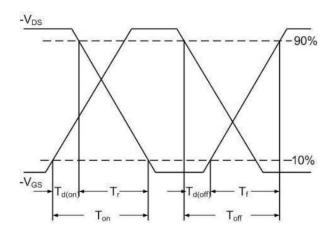


Fig.10 Switching Time Waveform

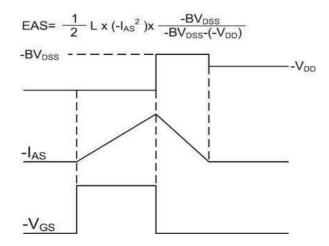
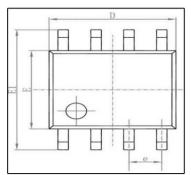


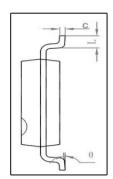
Fig.11 Unclamped Inductive Waveform

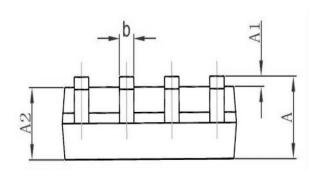




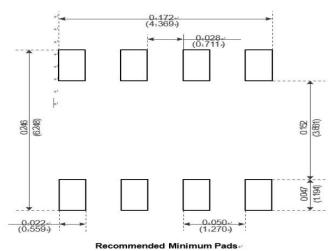
Package Mechanical Data-SOP-8L







Cl 1	Dimensions In	n Millimeters	Dimensions	In Inches
Symbol	Min	Max	Min	Max
Α	1. 350	1. 750	0. 053	0.069
A1	0. 100	0. 250	0.004	0. 010
A2	1. 350	1. 550	0.053	0. 061
b	0. 330	0. 510	0. 013	0. 020
С	0. 170	0. 250	0.006	0. 010
D	4. 700	5. 100	0. 185	0. 200
E	3.800	4. 000	0. 150	0. 157
E1	5. 800	6. 200	0. 228	0. 244
е	1. 270 (BSC)		0. 050 (BSC)	
L	0. 400	1. 270	0.016	0.050
θ	0°	8°	0°	8°



Package Marking and Ordering Information

Product ID	Pack		
TAPING	SOP-8L		3000

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